NikhefPixelated TPC technology for the future e⁺e⁻ collider



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FCC hh ee he

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- TPC is sliced between silicon detectors VTX, SIT and SET
- Material budget is
 - 0.01 X₀ TPC gas
 - **0.01** X₀ inner cylinder
 - 0.03 X₀ outer cylinder
 - < 0.25 X₀ endplates (incl readout)
- Note the very low budget in the barrel region. Material budget can be respected by different technologies like GEM, MicroMegas and GridPixes
 pixel readout is a serious option for the TPC readout plane @ ILC/FFC-ee/CLIC/CEPC colliders

https://www.nikhef.nl/pub/services/biblio/theses_pdf/ thesis_C_Ligtenberg.pdf

GridPix technology

- Pixel chip with integrated Grid (Micromegas-like)
- InGrid post-processed @ IZM
- Grid set at negative voltage (300 600 V) to provide gas amplification
- Very small pixel size (55 μm)
- detecting individual electrons
- Aluminium grid (1 μm thick)
- 35 μm wide holes, 55 μm pitch
- Supported by SU8 pillars 50 µm high
 Grid surrounded by SU8 dyke (150 µm wide solid strip) for mechanical and HV stability







Fraunhofer IZM

Stage at T = 50.0

Chamber = 6.64e-004 Pa

20 µm*



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Picture IHEP

Pixel chip: Timepix3

- 256 x 256 pixels
- 55 x 55 μm pitch
- 14.1 x 14.1 mm sensitive area
- TDC with 640 MHz clock (1.56 ns)
- Used in the data driven mode
 - Each hit consists of the **pixel address** and **time stamp** of arrival time (ToA)
 - Time over threshold (ToT) is added to register the signal amplitude
 - compensation for time walk
 - Trigger (for t₀) added to the data stream as an additional time stamp
- Power consumption
 - ~1 A @ 2 V (2W) depending on hit rate
 - good cooling is important





Single hit resolution in transverse direction



Results from Bonn-Elsa testbeam in 2017 https://doi.org/10.1016/j.nima.2018.08.012

Single hit resolution in pixel plane:

$$\sigma_y^2 = \sigma_{y0}^2 + D_T^2(z - z_0)$$

Depends on: pixel size / √12 Diffusion from fit

Note that:

A hit resolution of 250 μm is 25 μm for a 100-hit track (1 cm track length)

□ At 4 T , D_T = 25µm/ √cm

QUAD design and realization

- Four-TimePix3 chips
- All services (signal IO, LV power) are located under the detection surface
- The area for connections was squeezed to the minimum
- Very high precision 10 µm mounting of the chips and guard
- QUAD has a sensitive area of 68.9%
- DAQ by SPIDR









QUAD test beam in Bonn (October 2018)

- ELSA: 2.5 GeV electrons
- Tracks referenced by Mimosa telescope
- QUAD sandwiched between Mimosa planes
 - Largely improved track definition
 - 6 planes with 18.4 μm × 18.4 μm sized pixels
- Gas: Ar/CF₄/iC₄H₁₀ 95/3/2 (T2K)
- $E_{d} = 400 \text{ V/cm}, V_{arid} = -330 \text{ V}$
- Typical beam height above the chip: ~1 cm



Published NIMA https://doi.org/10.1016/j.nima.2019.163331





The D_T value is rather high due to an error in the gas mixing (too low CF₄)

QUAD edge deformations (XY)





QUAD deformations in transverse plane (XY)

- After applying fitted edge corrections
- RMS of the mean residuals are 13 µm over the whole QUAD





QUAD as a building block

8-QUAD module (2x4 quads) with field cage







in red guard wires



DESY testbeam June 2021





Mounting the 8 quad module between the silicon planes sliding it into the 1 T PCMAG solenoid







DESY testbeam June 2021









arrival time (ns)



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Run 6916 B=0 T p =6 GeV

Preliminary

800

700

600

500

400F

300F

200

100



964 selected tracks Impressive 1009 hits / track





8-quad module Tracking precision: position 9 μ m (xy) 13 μ m (z) angle 0.19 mrad (dx/dy) 0.25 (dz/dy) mrad module tracklength = 157.96 mm

Note that in a B field because of the reduced diffusion the tracking precision will improve substantially



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Run 6916-6918 B=0 T p=6 GeV

Three runs at different drift distances







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DESY testbeam Module Analysis

Run 6916-6918 B=0 T p=6 GeV

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Fitted resolution
$$\sigma_{xy_{,z}^{2}}^{2} = \sigma_{xy_{0,z_{0}}^{2}}^{2} + D_{xy_{,z}^{2}}^{2} (z - z_{0})$$



Magboltz gives D_T 287 μ m/ \sqrt{cm}

T2K* = T2K gas with O_2 and H_2O





Run 6983-6990 B=1 T p=5 and 6 GeV

Fitted resolution

$$\sigma_{xy_{,}z^{2}} = \sigma^{2}_{xy_{0,}z_{0}} + D^{2}_{xy_{,}z} (z - z_{0})$$



 $\sigma^{2}_{xy0} = \sigma^{2}_{pixel} + \sigma^{2}_{xytele}$ $\sigma^{2}_{pixel} = 55^{2}/12 \,\mu m^{2}$ $\sigma_{xytele} = 42 \,\mu m$

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Magboltz gives for $D_T = 121 \ \mu m/\sqrt{cm}$

T2K* = T2K gas with O_2 and H_2O







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y in pixels

Mean residuals in the module plane with acceptance cuts





Runs 6981-6988 B=1 T p=5 GeV

Mean residuals in the module plane with acceptance cuts

y in pixels



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Runs 6909, 6916-17, 6934-35 B=0 T p =6,5 GeV UNIVERSITÄT BONN

Distribution of mean residuals in the plane



See back up slide for the two methods that group the module plane

| method | rms (stat) xy | bins xy | rms (stat) z | bins z |
|--------|------------------|------------|-----------------|--------|
| row | 10 (5) μm | 1280 | 12 (5) μm | 638 |
| column | 11 (5) μm | 1280 | 11 (5) μm | 636 |

We did not include the 4 corner chips and (11), 14, 8, 13 and 19. These are affected by the field cage and the short in chip 11.



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-0.2-0.15-0.1-0.05 0 0.05 0.1 0.15 0.2

systematics module xy (mm)

DESY testbeam Module Analysis

Runs 6983-6988 B=1T p=5 GeV



Distribution of mean residuals in the plane



-0.2-0.15-0.1-0.05 0 0.05 0.1 0.15 0.2

systematics module z (mm)





• B=0 T has a large Landau tail

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- B=1 T smaller Landau tail and a more Gaussian distribution
 - An electron crossing 8 chips in the module has about 1000 TX3 hits



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The dE/dx resolution for MIPs (70% of the electron dE/dx) from data by combining tracks to form a 1 m long track with realistic coverage ~60% coverage (corrected for the e-MIP scale).

| Method | B=0 Resolution (%) | B= 1 T Resolution (%) |
|-------------------|--------------------|-----------------------|
| (1) dE/dx 90 | 8.6 | 6.3 |
| (2) dE/dx 90 tail | 7.7 | 5.4 |
| (3) Fit amplitude | 9.0 | 6.0 |
| (3) Fit slope | 6.7 | 4.0 |

Method (1) dE/dx 90 is truncation at 90%; in (2) large clusters are scanned and removed; The "Fit slope/amplitude" method (3); where the exponential slope and amplitude of the distance between the hits is fitted. The slope gives the best resolution of 4.0%.





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Summary of the Pixel TPC performance

- A single chip GridPix detector was reliably operated in a test beam in 2017
 - Single electron detection => the resolution is primarily limited by diffusion
 - Systematic uncertainties are low: < 10 μm in the pixel xy plane
- A Quad detector was designed and the results from the 2018 test beam shown
 - Small edge deformations at the boundary between two chips are observed
 - added guard wires to the module to obtain a homogeneous field
 - After correcting the edges, deformations in the transverse plane shown to be < 15 μm
- An 8-Quad module has been designed with guard wires
- Preliminary test beam results are excellent
 - **High precision at B=1 T:** D_T = 120 μ m/ \sqrt{cm} and deformations in xy < 15 μ m
 - dE/dx resolution for a MIP 1 m track with 60% coverage is 4.1% (at 1 Tesla)
 - The tracking precision: position 9 (xy) 13 μm (z) in angle 0.19 (dx/dy) 0.25 (dz/dy) mrad for a module or tracklength is 157.96 mm
- A test beam @ FermiLab with the module in a TPC is planned (US Grant EIC)
- A pixel TPC has become a realistic viable option for experiments
 - High precision tracking like ILD@ILC in the transverse and longitudinal planes, dE/dx by electron and cluster counting, excellent two track resolution, digital readout that can deal with high rates

A Pixel TPC at CEPC or FCC-ee

The most difficult situation for a TPC is running at the Z.

At the Z pole with L = 200×10^{34} cm⁻² s⁻¹ Z bosons will be produced at 60 kHz





Can a pixel TPC reconstruct the events?

- The TPC total drift time is about 30 μs
- This means that there is on average 2 event / TPC readout cycle
- YES: The excellent time resolution: time stamping of tracks < 1.2 ns allows to resolve and reconstruct the events</p>

Can the current readout deal with the rate?

- Link speed of Timepix3 (in Quad) is 80 Mbps: 2.6 MHits/s per 1.41 × 1.41 cm²
- YES: This is largely sufficient to deal with high luminosity Z running
- NB: Data size is not a show stopper as e.g. LHCb experiment shows using the VeloPix chip

A Pixel TPC at CEPC or FCC-ee

What is the current power consumption?

- No power pulsing possible at these colliders (at ILC power pulsing was possible)
- Current power consumption TPX3 chip 2W/chip per 1.41 × 1.41 cm²
- So: good cooling is important but in my opinion no show stopper
- For Silicon detectors lower consumption for the chips and cooling is an important point that needs R&D (e.g. microchannel cooling).
- Note that the TPX3/4 chips can be run in LowPowerMode

Can one limit the track distortions?

- There are two important sources of track distortions:
 - the distortions of the TPC drift field due to the primary ions
 - the distortions of the TPC drift field due to the ion back flow (IBF)
- At the ILC gating is possible; for CEPC or FCC-ee this is more involved

A Pixel TPC at CEPC or FCC-ee

■ Is it possible to reduce the IBF for a pixel TPC?

- IDEA: by making chip with a double grid structure (see next slide)
- This idea was already realized as a TWINGRID NIMA 610 (2009) 644-648
- For GEMs for the ALICE TPC this was also the way several GEMs on top of each other to reduce IBF
- For the Pixel the IBF can be easily modelled and with a hole size of 25 μm an IBF of 3 10⁻⁴ can be achieved and the value for IBF*Gain (2000) would be 0.6.
- YES: the IBF can be reduced to 0.6 but this needs R&D
- In the new detector lab in Bonn it is possible to make and study this device
- What would be the size of the TPC distortions?
 - Recent Tera-Z studies by Daniel Jeans and <u>Keisuke Fuji</u> show that for FCC-ee or CEPC this means: distortions from Z decays up to < O(100) μm</p>
 - Beam strahlung gives (now) a factor 200 more background. Detector optimization and shielding is important for TPC and Silicon detectors to reduce pair background.
 - Recently I argued that in an <u>ILD like detector</u> the distortions can be mapped out using the VTX-SIT/SET detectors.

Reducing the Ion back flow in a Pixel TPC

The Ion back flow can be reduced by adding a second grid to the device. It is important that the holes of the grids are aligned. The Ion back flow is a function of the geometry and electric fields. Detailed simulations – validated by data - have been presented in LCTPC WP #326.

With a hole size of 25 μ m an IBF of 3 10⁻⁴ can be achieved and the value for IBF*Gain (2000) would be 0.6.



| Ion backflow | Hole 30 µm | Hole 25 µm | Hole 20 µm |
|--------------|------------|------------|------------|
| Top grid | 2.2% | 1.2% | 0.7% |
| GridPix | 5.5% | 2.8% | 1.7% |
| Total | 12 10-4 | 3 10-4 | 1 10-4 |
| transparancy | 100% | 99.4% | 91.7% |

Conclusions: Pixel TPC at CEPC

- YES: a pixel TPC can reconstruct the Z events in one readout cycle
- YES: the current readout of the Timepix3 chip can deal with the rate
- The current power consumption is 1W/cm². So good cooling is important but in my opinion no show stopper; but needs extensive R&D.
- Track distortions in the TPC drift volume are a concern at high lumi Z running:
 - Track distortions from Z decays in TPC are O(100) μm
 - It is possible to reduce the IBF for a pixel TPC by making a device with a double grid
 - This needs dedicated R&D that can be performed in the new lab in Bonn
- The Z physics program at FCC-ee or CEPC with an ILD-like detector with a Pixel TPC (with double grid structures) sliced between two silicon trackers (VTX-SIT and SET) can be fully exploited. The reduction of beamstrahlung needs more study.
- A pixel TPC can perfectly run at WW, ZH or tt energies where track distortions are several orders of magnitude smaller

Backup

Pictures of repair work in Bonn for the EIC TPC project



The short in chip 11 was succesully repaired by Fred Hartjes



Runs 6909, 6916-17, 6934-35 B=0 T p =6,5 GeV

Mean residuals (module) row

(module) column



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- Preliminary results of the 8 Quad module in the DESY test beam in June 2021 have been presented
- One chip (nr 11) out of 32 was disconnected due to a short*
- In run 6916 e.g. 964 tracks were selected with 1009 hits on track
- The tracking precision: position 9 (xy) 13 μm (z) in angle 0.19 (dx/dy) 0.25 (dz/dy) mrad for a module or tracklength is 157.96 mm
- **The diffusion coefficients at B=0 T** D_{xy} = 287 μ m/ \sqrt{cm} D_z = 273 μ m/ \sqrt{cm}
- **The diffusion coefficients at B=1 T is** $D_{xy} = 120 \ \mu m/\sqrt{cm}$ $D_z = 251 \ \mu m/\sqrt{cm}$
- In agreement with Magboltz $D_{xy} = 121 \,\mu m/\sqrt{cm}$



*the chip was successfully repaired in 2023 Bonn see backup slide



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Preliminary Conclusions on module



- Results for the module showed that:
 - the HV of the guard wires was well tuned
 - B=0 T rms residuals in the module plane xy 12 μm and z 14 μm
 - The results are compatible with (very) high stats quad measurement
 - **B**= 1T rms residuals in the plane xy 14 μ m and z 22 μ m;
- High tracking precision demonstrated with small systematics
 - deformations xy stay below 12(14) μm
- Particle identification based on the numbers of hits and their distance.
 - the "Fit slope" method gives a dE/dx MIP resolution of 4.0% for a 1 m track with realistic ~60% coverage of the readout plane in a 1 T B field
 - NB this is much better than our single chip dE/dx result at B = 0 T.





Simulation of ILD TPC with pixel readout

- To study the performance of a large pixelized TPC, the pixel readout was implemented in the full ILD DD4HEP (Geant4) simulation
- Changed the existing TPC pad readout to a pixel readout
- Adapted Kalman filter track reconstruction to pixels



22 electrons / hit ~ 200 hits / track





details: PhD <u>thesis</u> Kees Ligtenberg



50 GeV muon track with pixel readout

Performance of a GridPix TPC at ILC

- From full simulation the momentum resolution can be determined
- Momentum resolution is about 15% better for the pixels with realistic coverage (with the quads arranged in modules coverage 59%) and deltas.



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